

Electronic Filing System (EFS) Data
Electronic Patent Application Submission
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EFS ID: 15148
Application ID: 10063737
Title of Invention: VOLTAGE REFERENCE CIRCUIT
LAYOUT INSIDE MULTI-LAYERED
SUBSTRATE
First Named Inventor: Jimmy Hsu
Domestic/Foreign Application: Domestic Application
Filing Date: null
Effective Receipt Date: 2002-05-09
Submission Type: Utility Patent Filing
Filing Type: new-utility
Confirmation Number: 0
Attorney Docket Number: 8727-US-PA
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Trademark Office, ou=Department of Commerce, o=U.S.
Government, c=US
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Total Fees Authorized: \$972.0

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TRANSMITTAL FORM

Electronic Version 1.0.3

Stylesheet Version: 1.0

Submission Type: Utility Patent
Filing

Attorney Docket
Number:

8727-US-
PA

VOLTAGE REFERENCE CIRCUIT LAYOUT INSIDE MULTI-LAYERED SUBSTRATE



First Named Inventor: Mr. Jimmy Hsu

SUBMITTED BY

Name: Dr. Belinda Lee
Registration Number: 46,863
Electronic Signature Mark: /BL Date Signed: 20020509

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I, the undersigned, certify that I have viewed a display of document(s) being electronically submitted to the United States Patent and Trademark Office, using either the USPTO provided style sheet or software, and that this is the document(s) I intend for initiation or further prosecution of a patent application noted in the submission. This document(s) will become part of the official electronic record at the USPTO.

Attached Files:

declaration	8727declaration1.tif
declaration	8727declaration2.tif
bibd-transmittal	8727usapds.xml

specification
fee-transmittal
patent-assignments

8727usf.xml
8727usfee.xml
8727usasgn.xml

Attached Image File(s):

8727declaration1.tif
8727declaration2.tif

8727declaration1.tif

Comments:

2020-2-23-2021

COMBINED DECLARATION AND POWER OF ATTORNEY

As the below named inventor, I hereby declare that:

My residence, post office address and citizenship are as stated below next to my name and that I believe I am an original, first and sole inventor (if only one name is listed below) or an original, first and joint inventor (if plural names are listed below) of the subject matter which is claimed and for which a patent is sought on the invention entitled

VOLTAGE REFERENCE CIRCUIT LAYOUT INSIDE MULTI-LAYERED SUBSTRATE

the specification of which

☒ is attached hereto.

☐ was filed on _____

as Application Serial No. _____ and was amended on _____.

I hereby state that I have reviewed and understand the contents of the above-identified specification, including the claims, as amended by any amendment referred to above.

I acknowledge the duty to disclose information which is material to the patentability of this application in accordance with Title 37, Code of Federal Regulations, § 1.56(a).

I hereby claim foreign priority benefits under Title 35, United States Code, § 119 of any foreign application(s) for patent or inventor's certificate listed below and have also identified below any foreign application for patent or inventor's certificate having a filing date before that of the application on which priority is claimed:

Prior Foreign Application(s):

Number	Country	Date Filed(yyyy/mm/dd)	Yes	No
91102057	Taiwan, R.O.C.	2002/2/6	X	

I hereby appoint the following attorney(s) and/or agent(s) to prosecute this application and to transact all business in the Patent and Trademark Office connected therewith:

Jiawei Huang

(Reg. No. 43,330)

Belinda Lee

(Reg. No. 46,863)

Charles C.H. Wu

(Reg. No. 39,081)

Maria Erlinda
Sarno

C. (Reg. No. 37,436);

SEND CORRESPONDENCE TO:

DIRECT TELEPHONE CALLS TO:

(Name and Telephone Number)

JIANQ CHYUN Intellectual Property Office
7F.-1, No. 100, Roosevelt Rd., Sec. 2,
Taipei 100, Taiwan, R.O.C.

Belinda Lee

886-2-2369 2800

COMBINED DECLARATION AND POWER OF ATTORNEY CONTINUED

I hereby declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Section 1001 of Title 18 of the United States Code and that such willful false statements may jeopardize the validity of the application or any patents issued thereon.

Signature

Jimmy Hsu

Date

Mar. 05, 2022

Sole or First Joint Inventor: Jimmy Hsu

Citizenship: Taiwan, R.O.C.

Residence and Post Office Address: 8F, No. 533, Chung-Cheng Rd., Hsintien, Taipei Hsien, Taiwan, R.O.C.

FEE TRANSMITTAL

Electronic Version 1.1.0

Stylesheet Version: 1.0

Patent fees are subject to annual revisions on or about October 1st of each year.

Large Entity

TOTAL FEES AUTHORIZED: \$ 972

BANK (CREDIT) CARD INFORMATION:

Credit Card Number: 3109
Expiration Date: 20030430
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BASIC FILING FEE

Fee Description	Fee Code	Fee Paid
Utility Filing Fee	101	\$ 740

Subtotal For Basic Filing Fee: \$ 740

EXTRA CLAIM FEES

	Fee Code	Fee	Extra Claims	Fee Paid
Total Claims: 26	103	\$ 18	6	\$ 108
Independent Claims: 4	102	\$ 84	1	\$ 84

Subtotal For Extra Claims Fees: \$ 192

ADDITIONAL FEES

Fee Description	Number	Quantity	Fee Code	Amount	Fee Paid
Recording Each Patent Assignment Per Property Fee	00000000	1	581	\$ 40	\$ 40

Subtotal For Additional Fees: \$ 40